

## **Application Data Sheet**

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### **Inventor Information**

Inventor One Given Name:	Takahide
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Name Suffix:	
Postal Address Line One	8-81, Yurigaokahigashi
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Postal or Zip Code:	
Citizenship Country:	Japan
Inventor Two Given Name:	Osamu
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Postal or Zip Code:	
Citizenship Country:	Japan

### **Correspondence Information**

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### **Application Information**

Title Line One:	SEMICONDUCTOR LASER PACKAGE AND
Title Line Two:	FABRICATION METHOD THEREOF
Total Drawing Sheets:	6
Formal Drawings?:	Yes
Application Type:	Utility

Docket Number: 245402004300

**Representative Information**

Representative Customer Number: 25226

**Continuity Information**

This application is a:

> Application One:

Filing Date:

which is a:

>>Application Two:

Filing Date:

which is a:

>>>Application Three:

Filing Date:

**Prior Foreign Applications**

Foreign Application One:

2001-025259

Filing Date:

February 1, 2001

Country:

Japan

Priority Claimed:

Yes